
High Purity Silicon 11

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Sponsoring Division:



Electronics and Photonics



Published by

The Electrochemical Society

65 South Main Street, Building D
Pennington, NJ 08534-2839, USA

tel 609 737 1902

fax 609 737 2743

www.electrochem.org

ecstransactions™

Vol. 33, No. 11

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Published by:

The Electrochemical Society
65 South Main Street
Pennington, New Jersey 08534-2839, USA

Telephone 609.737.1902
Fax 609.737.2743
e-mail: ecs@electrochem.org
Web: www.electrochem.org

ISSN 1938-6737 (online)
ISSN 1938-5862 (print)
ISSN 2151-2051 (cd-rom)

ISBN 978-1-56677-830-5 (PDF)
ISBN 978-1-60768-180-9 (Softcover)

Printed in the United States of America.

ECS Transactions, Volume 33, Issue 11
High Purity Silicon 11

Table of Contents

Preface *iii*

Chapter 1
Keynote Papers

(Invited) Nano Characterization of Materials 3
D. K. Schroder

(Invited) Recent Advances in the Smart Cut Technology for CMOS Applications 23
O. Kononchuk, D. Landru, C. Veytizou, and E. Guiot

Chapter 2
Hydrogen Defects and Engineering

(Invited) Germanium on Sapphire Technology 37
*H. S. Gamble, P. B. Baine, Y. H. Low, P. V. Rainey, J. H. Montgomery, M. Bain,
B. Armstrong, D. W. McNeill, and N. S. Mitchell*

The Impact of Helium Co-Implantation on Hydrogen Induced Donor Profiles in Float
Zone Silicon 51
*J. Laven, R. Job, H. Schulze, F. Niedernostheide, V. Häublein, H. Schulze,
W. Schustereder, H. Rysse, and L. Frey*

(Invited) Practical Method and Physics of Evaluation for Vacancy Concentration of
Silicon Crystals by Measuring Low-Temperature Elastic Softening 63
*H. Yamada-Kaneta, S. Baba, Y. Nagai, M. Akatsu, K. Mitsumoto, T. Yanase, K. Okabe,
Y. Ono, Y. Nemoto, and T. Goto*

Chapter 3
Crystal Growth

Point Defects in Silicon Melt Growth from the Experimental Results 75
T. Abe and T. Takahashi

Chapter 4
Defect Engineering and Gettering in Silicon

(Invited) Lifetime Degradation in Boron Doped Czochralski Silicon <i>V. V. Voronkov, R. J. Falster, J. Schmidt, K. Bothe, and A. Batunina</i>	103
Getter Effects in Low Oxygen and High Oxygen Czochralski Silicon Wafers <i>G. Kissinger, D. Kot, and W. Häckl</i>	113
Minority Carrier Lifetime in Czochralski Silicon Containing Oxide Precipitates <i>J. D. Murphy, K. Bothe, M. Olmo, V. V. Voronkov, and R. J. Falster</i>	121
Niobium Contamination in Silicon <i>M. Polignano, D. Codegoni, G. Borionetti, F. Bonoli, J. Brivio, S. Greco, A. Marino, P. Monge, I. Patoprsta, V. Privitera, and C. Riva</i>	133
A DLTS Study of SiO ₂ and SiO ₂ /SiN _x Bi-Layer Surface Passivation of Silicon <i>E. Simoen, C. Gong, N. Posthuma, E. Van Kerschaver, J. Poortmans, and R. Mertens</i>	145

Chapter 5
Poster Session

Modeling of Hydrogen Diffusion And Segregation in Amorphous Silicon During Solid Phase Epitaxy <i>B. C. Johnson, M. Mastromatteo, D. De Salvador, E. Napolitani, A. Carnera, and J. McCallum</i>	157
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Chapter 6
Implantation, Defects and Annealing

(Invited) Recent Insights in the Diffusion of Boron in Silicon and Germanium <i>S. Mirabella, D. De Salvador, E. Bruno, E. Napolitani, G. Scapellato, M. Mastromatteo, G. Impellizzeri, G. Bisognin, S. Boninelli, A. Terrasi, A. Carnera, and F. Priolo</i>	167
Single Ion Implantation into Si-Based Devices <i>B. C. Johnson, G. Tettamanzi, C. Yang, A. Alves, J. van Donkelaar, S. Thompson, A. Verduijn, J. A. Mol, R. Wacquez, M. Vinet, A. Dzurak, M. Sanquer, S. Rogge, and D. Jamieson</i>	179

Combined IV and CV Analysis of Laser Annealed Carbon and Boron Implanted SiGe Epitaxial Layers	191
<i>D. Kobayashi, M. Bargallo-Gonzalez, E. Rosseel, A. Hikavy, K. Hirose, E. Simoen, and C. Claeys</i>	

Chapter 7

Strain Analysis and Modeling

(Invited) Nano-Beam Diffraction: Crystal Structure and Strain Analysis at the Nanoscale	205
<i>P. Favia, M. Popovici, G. Eneman, G. Wang, M. Bargallo-Gonzalez, E. Simoen, N. Menou, and H. Bender</i>	
(Invited) Impact of Stress and Defects on Advanced Junction Leakage	221
<i>V. Moroz and M. Choi</i>	
Recent Insights In Solid Phase Epitaxy of Silicon and Germanium	237
<i>B. C. Johnson, N. Stavrias, S. Kandasamy, D. Pyke, A. Holland, and J. McCallum</i>	
Author Index	249